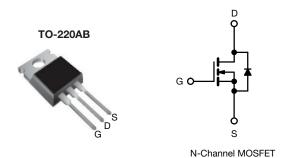
HALOGEN FREE



D Series Power MOSFET



PRODUCT SUMMA	RY	
V _{DS} (V) at T _J max.	450)
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V	1.0
Q _g max. (nC)	18	
Q _{gs} (nC)	3	
Q _{gd} (nC)	4	
Configuration	Sing	le

FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (Ciss)
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- · Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qq
 - Fast switching
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

APPLICATIONS

- Consumer electronics
 - Displays (LCD or plasma TV)
- · Server and telecom power supplies
 - SMPS
- Industrial
 - Welding
 - Induction heating
- Motor drives
- Battery chargers

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP6N40D-E3
Lead (Pb)-free and halogen-free	SiHP6N40D-BE3 ^a
Lead (Fb)-free and halogen-free	SiHP6N40D-GE3

a. "-BE3" denotes alternate manufacturing location

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	400		
Gate-source voltage		V	± 30	V	
Gate-source voltage AC (f > 1 Hz)		V _{GS}	30		
Continuous drain current (T _{.I} = 150 °C)	V_{GS} at 10 V $\frac{T_C = 25 ^{\circ}}{T_C = 100 ^{\circ}}$	C ,	6		
Continuous drain current (1) = 150 °C)	V_{GS} at 10 V_{CS} $T_{C} = 100^{\circ}$	C I _D	4	Α	
Pulsed drain current ^a	·	I _{DM}	13		
Linear derating factor			0.8	W/°C	
Single pulse avalanche energy b		E _{AS}	104	mJ	
Maximum power dissipation		P _D	104	W	
Operating junction and storage temperature range		T _J , T _{stq}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C	dV/dt	24	V/ns	
Reverse diode dV/dt d		uv/at	0.48	7 7/115	
Soldering recommendations (peak temperature) c	For 10 s		300	°C	

Notes

- Repetitive rating; pulse width limited by maximum junction temperature V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 9.5 A
- 1.6 mm from case
- d. $I_{SD} \le I_D$, starting $T_J = 25$ °C



Vishay Siliconix

THERMAL RESISTANCE RAT	INGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	62	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	1.2	C/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-					
Drain-source breakdown voltage	V _{DS}	V _{GS} =	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 250 μA	-	0.53	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = 250 μA	3	-	5	V
Gate-source leakage	I _{GSS}	1	$V_{GS} = \pm 30 \text{ V}$	-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}		400 V, V _{GS} = 0 V , V _{GS} = 0 V, T _J = 125 °C	-	-	1 10	μΑ
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 3 A	-	0.85	1.0	Ω
Forward transconductance	9fs		= 50 V, I _D = 3 A	-	1.7	-	S
Dynamic				L	1		
Input capacitance	C _{iss}	V _{GS} = 0 V,		-	311	-	-
Output capacitance	C _{oss}	∃ ,	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		38	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	7	-	1
Effective output capacitance, energy related ^a	C _{o(er)}	V _{GS} = 0 V, V _{DS} = 0 V to 320 V		-	44	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	54	-	
Total gate charge	Qg			-	9	18	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 3 \text{ A}, V_{DS} = 320 \text{ V}$		-	3	-	nC
Gate-drain charge	Q _{gd}			-	4	-	
Turn-on delay time	t _{d(on)}			-	12	24	
Rise time	t _r	V_{DD} = 400 V, I_{D} = 3 A, V_{GS} = 10 V, R_{g} = 9.1 Ω		-	11	22	200
Turn-off delay time	t _{d(off)}			-	14	28	ns
Fall time	t _f			-	8	16	
Gate input resistance	R_g	f = 1 MHz, open drain		1.0	1.9	3.8	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	showing the			-	6	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	24	A
Diode forward voltage	V_{SD}	T _J = 25 °C, I _S = 3 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	_		-	236	-	ns
Reverse recovery charge	Q _{rr}		$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 3 \text{A},$ $dI/dt = 100 \text{A/}\mu\text{s}, V_B = 20 \text{V}$		1.1	-	μC
Reverse recovery current	I _{RRM}	$\frac{1}{2} \text{di/dl} = 100 \text{ A/} \mu \text{s}, \text{ V}_{\text{R}} = 20 \text{ V}$		-	9	-	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

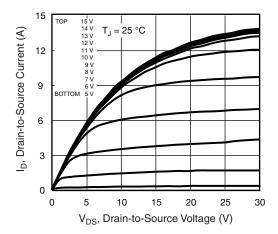


Fig. 1 - Typical Output Characteristics

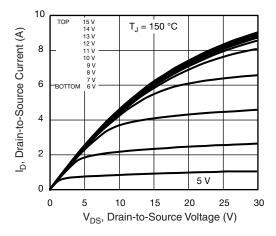


Fig. 2 - Typical Output Characteristics

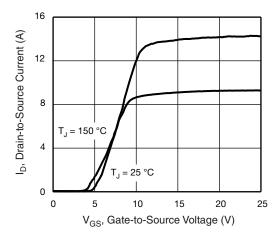


Fig. 3 - Typical Transfer Characteristics

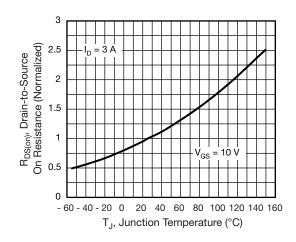


Fig. 4 - Normalized On-Resistance vs. Temperature

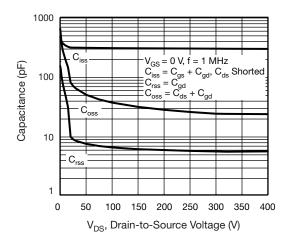


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

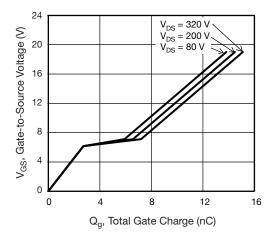


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



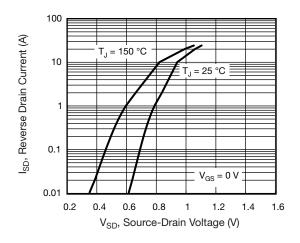


Fig. 7 - Typical Source-Drain Diode Forward Voltage

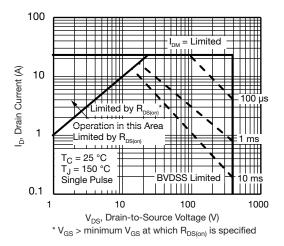


Fig. 8 - Maximum Safe Operating Area

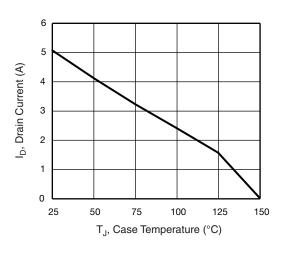


Fig. 9 - Maximum Drain Current vs. Case Temperature

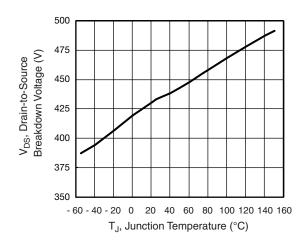


Fig. 10 - Temperature vs. Drain-to-Source Voltage

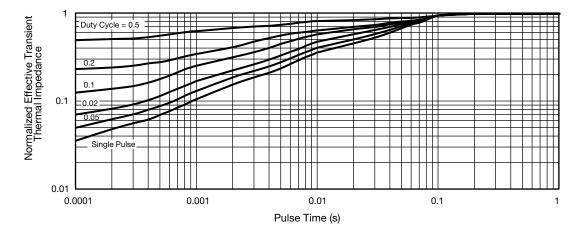


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

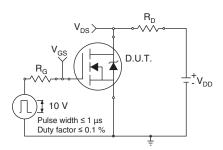


Fig. 12 - Switching Time Test Circuit

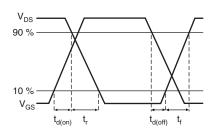


Fig. 13 - Switching Time Waveforms

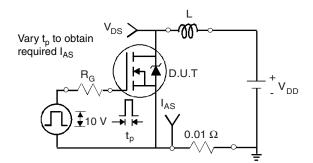


Fig. 14 - Unclamped Inductive Test Circuit

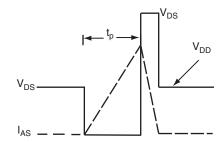


Fig. 15 - Unclamped Inductive Waveforms

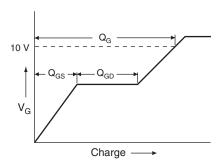


Fig. 16 - Basic Gate Charge Waveform

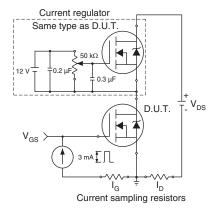
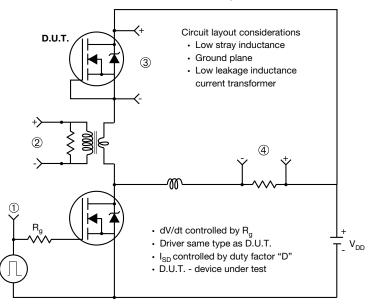


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



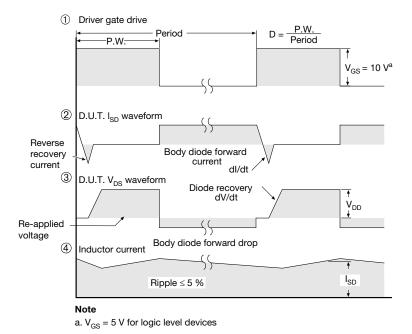


Fig. 18 - For N-Channel

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TO-220-1



DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
Α	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
Е	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØΡ	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

DWG: 6031

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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